

Antenna YC0013AA Datasheet

Antenna Services

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About the Document

Revision History

Version	Date	Author	Note
-	2020-12-14	Kenny YIN	Creation of the document
1.0	2020-12-14	Kenny YIN	First official release
2.0	2021-06-09	Aria CHU	Updated all test data in this datasheet.
2.1	2021-06-21	Aria CHU	Updated the efficiency and gain charts in Chapter 4.
2.2	2021-06-28	Aria CHU	Updated the efficiency and gain charts in Chapter 4.
2.3	2021-07-08	Aria CHU	Updated the reference PCB design in Chapter 4.8.

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1 Product Description

The antenna is designed for superior performance, and can be widely used for wireless applications.

We provide comprehensive antenna design support such as simulation, testing and manufacturing for custom antenna solutions to meet your specific application needs.

2 Product Features

- GNSS 1559–1606 MHz
- High efficiency
- Excellent performance



3 Product Specifications

• The antenna is tested on a 50 mm × 90 mm evaluation board.

Passive Electrical Specifications	
Frequency Range	1559–1606 MHz
Input Impendence	50 Ω
S11	< -10.2
Gain	> 1.19 dBi
Efficiency	≥ 59 %
Azimuth Beam Width	Omni-directional
Polarization Type	Linear
Mechanical Specifications	
Antenna Size	3.2 mm (L) × 1.6 mm (W) × 0.6 mm (H)
Carrier	Ceramic
Connector Type	SMD
Operating Temperature	-40 °C to + 85 °C

4 Overall Performance

4.1. Test Environment

- KEYSIGHT VNA Network Analyzer E5063A 100 kHz 8.5 GHz
- RayZone[®] 2800 Chamber 5G (FR1) SISO/MIMO, 400 MHz 8.0 GHz





4.2. Return Loss



Frequency (MHz)	1561	1575	1602
S11	-12.3	-24.9	-10.2



4.3. Efficiency



Frequency (MHz)	1561	1575	1602
Efficiency (%)	84	79	59



4.4. Gain



Frequency (MHz)	1561	1575	1602
Gain (dBi)	2.89	4.18	1.19

4.5. Radiation Pattern

• Board length: 90 mm













4.6. Schematic Symbol and Pin Definition

The pin assignment for the antenna is as follows. The antenna has 2 pins which both work. All other pins are designed for mechanical strength.



Pin No.	Description
1	Feed (GND)
2	GND (Feed)

4.7. Transmission Line

The characteristic impedance of all transmission lines shall be designed as 50 Ω .

- The length of the transmission lines should be kept as short as possible.
- Any other part of the RF system, such as transceiver, power amplifiers, etc., shall also be designed with an impedance of 50 Ω.

4.8. Reference PCB Design (Unit: mm)



4.9. Matching Circuit



5 Product Size (Unit: mm)

ROHS



6 Dependability Test

Reference Condition:	Temperature range	25±5℃
	Relative Humidity range	55~75%RH
	Operating Temperature range	-40℃~+85℃
	Storage Temperature range	-40℃~+85℃

6.1 Vibration Resist

The device should satisfy the electrical characteristics specified in paragraph $8.1 \sim 8.4$ after applied to the vibration of 10 to 55Hz with amplitude of 1.5mm for 2 hours each in X, Y and Z directions.

6.2 Drop Shock

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after dropping onto the hard wooden board from the height of 100cm for 3 times each facet of the 3 dimensions of the device.

6.3 Solder Heat Proof

The device should be satisfied after preheating at 120° - 150° for 120 seconds and dipping in soldering Sn at 255° + 10° for 5 ± 0.5 seconds, or electric iron 300° - 10° for 3 ± 0.5 seconds, without damnify.

6.4 Adhesive Strength of Termination

The device have no remarkable damage or removal of the termination after horizontal force of $5N(\leq 0603)$; 10N(>0603) with 10 ± 1 seconds.

6.5 Bending Resist Test



Weld the product to the center part of the PCB with the thickness 1.6 ± 0.2 mm as the illustration shows, and keep exerting force arrow-ward on it at speed of :1mm/S, and hold for 5 ± 1 S at the position of 1.5mm bending distance, so far, any peeling off of the detected.

6.6 Moisture Proof

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to the temperature 60 ± 2 °C and the relative humidity 90~95% RH for 96 hours and 1~2 hours recovery time under normal condition.

6.7 High Temperature Endurance

The device should satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to temperature 85 ± 5 °C for 96 ± 2 hours and 1~2 hours recovery time under normal temperature.

6.8 Low Temperature Endurance

The device should also satisfy the electrical characteristics specified in paragraph 8.1~8.4 after exposed to the temperature $-40^{\circ}C \pm 5^{\circ}C$ for 96 ± 2 hours and to 2 hours recovery time under normal temperature.

6.9 Temperature Cycle Test

The device should also satisfy the electrical characteristics specified in paragraph $8.1 \sim 8.4$ after exposed to the low temperature -40° and high temperature $+85^{\circ}$ for 30 ± 2 min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.



7 Reflow Profile



8 Packaging and Dimensions

8.1 Plastic Tape



Remarks for Package

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier. 8. 2 Ree | (3000 pcs/Ree |)



8.3 Storage Period

Product should be used within six months of receipt.

MSL 1 / Storage Temperature Range : <30 degree C, Humidity : <85%RH